

Application No. 09/909,934
Filed: July 20, 2001
TC Art Unit: 2827
Confirmation No.: 2402

AMENDMENT TO THE CLAIMS

1. (Previously Presented) A stress-free lead frame (1) comprising:
a plurality of integrated circuit areas (11), each of said plurality of integrated circuit areas having a die pad (12) and a plurality of leads ; and
a peripheral pad (14) surrounding said plurality of integrated circuit areas,
said peripheral pad (14) being provided with a plurality of stress-relief means (15).
2. (Currently Amended) A stress-free lead frame (1) comprising:
a plurality of integrated circuit areas (11), each of said plurality of integrated circuit areas having a die pad (12) and a plurality of leads (13); and
a peripheral pad (14) surrounding said plurality of integrated circuit areas, — said peripheral pad (14) being provided with a plurality of interlocking means (16).